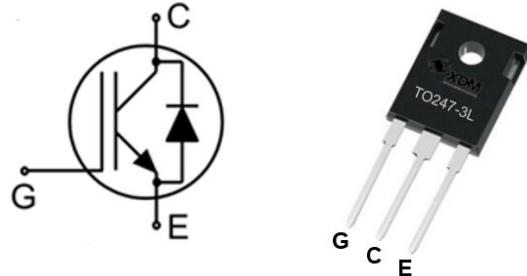


## Trench Field-Stop Technology IGBT

### Features

- 650V, 50A
- $V_{CE(sat)(typ.)} = 1.6V @ V_{GE}=15V, I_C=50A$
- Maximum Junction Temperature 175°C
- Pb-free Lead Plating; RoHS Compliant



### Applications

- Solar Converters
- Uninterrupted Power Supply
- Welding Converters
- Mid to High Range Switching Frequency Converters

### Key Performance and Package Parameters

Order codes	$V_{CE}$	$I_C$	$V_{CEsat}, T_{vj}=25^\circ C$	$T_{vjmax}$	Marking	Package
XD050H065A1S3-B	650V	50A	1.6V	175°C	D50H65A1B	TO247-3L

### Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
$V_{CES}$	Collector-Emitter Voltage	650	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_C$	Continuous Collector Current ( $T_c=25^\circ C$ )	100	A
	Continuous Collector Current ( $T_c=100^\circ C$ )	50	A
$I_{CM}$	Pulsed Collector Current (Note 1)	200	A
$T_{sc}$	Short Circuit Withstand Time, $V_{GE}= 15V, V_{CE} \leq 300V$	5	us
$P_D$	Maximum Power Dissipation (IGBT)	300	W
	Maximum Power Dissipation (FRD)	230	W
$T_J$	Operating Junction Temperature Range	-40 to 175	°C
$T_{STG}$	Storage Temperature Range	-40 to 175	°C

### Thermal Data

Symbol	Parameter	Conditions	Typ.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case for IGBT	TO247-3L	0.5	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case for Diodes	TO247-3L	0.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-Ambient	TO247-3L	40	°C/W

**Electrical Characteristics** ( $T_c=25^\circ\text{C}$  unless otherwise noted.)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{CES}}$	Collector-Emitter Breakdown Voltage	$V_{\text{GE}}=0\text{V}$ , $I_{\text{C}}=500\mu\text{A}$	650	---	---	V
$I_{\text{CES}}$	Collector-Emitter Leakage Current	$V_{\text{CE}}=650\text{V}$ , $V_{\text{GE}}=0\text{V}$	---	---	250	$\mu\text{A}$
$I_{\text{GES}}$	Gate Leakage Current, Forward	$V_{\text{GE}}=20\text{V}$ , $V_{\text{CE}}=0\text{V}$	---	---	200	nA
	Gate Leakage Current, Reverse	$V_{\text{GE}}=-20\text{V}$ , $V_{\text{CE}}=0\text{V}$	---	---	200	nA
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GE}}=V_{\text{CE}}$ , $I_{\text{C}}=250\mu\text{A}$	5.0	5.8	6.6	V
$V_{\text{CE}(\text{sat})}$	Collector-Emitter Saturation Voltage	$V_{\text{GE}}=15\text{V}$ , $I_{\text{C}}=50\text{A}$ , $T_j=25^\circ\text{C}$	---	1.6	2.0	V
$Q_G$	Total Gate Charge	$V_{\text{CC}}=520\text{V}$ $V_{\text{GE}}=15\text{V}$ $I_{\text{C}}=50\text{A}$	---	215	---	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{CC}}=400\text{V}$ $V_{\text{GE}}=\pm 15\text{V}$ $I_{\text{C}}=50\text{A}$ $R_{\text{G}}=10\Omega$ Inductive Load $T_c=25^\circ\text{C}$	---	85	---	ns
$t_r$	Turn-on Rise Time		---	42	---	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		---	180	---	ns
$t_f$	Turn-off Fall Time		---	100	---	ns
$E_{\text{on}}$	Turn-on Switching Loss		---	1.0	---	mJ
$E_{\text{off}}$	Turn-off Switching Loss		---	0.7	---	mJ
$E_{\text{ts}}$	Total Switching Loss		---	1.7	---	mJ
$C_{\text{ies}}$	Input Capacitance	$V_{\text{CE}}=25\text{V}$ $V_{\text{GE}}=0\text{V}$ $f=1\text{MHz}$	---	6800	---	pF
$C_{\text{oes}}$	Output Capacitance		---	200	---	pF
$C_{\text{res}}$	Reverse Transfer Capacitance		---	72	---	pF

**Diode Characteristics** ( $T_c=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_F$	Diode Forward Voltage	$I_F=50A, T_j=25^\circ C$	---	2.1	3.0	V
$t_{rr}$	Diode Reverse Recovery Time	$VR=400V$ $I_F=50A$ $dI_F/dt=500A/\mu s$	---	40	---	ns
$I_{rr}$	Diode peak Reverse Recovery Current		---	7.7	---	A
$Q_{rr}$	Diode Reverse Recovery Charge		---	0.35	---	$\mu C$

Note1: Repetitive rating, pulse width limited by maximum junction temperature

## Typical Characteristics

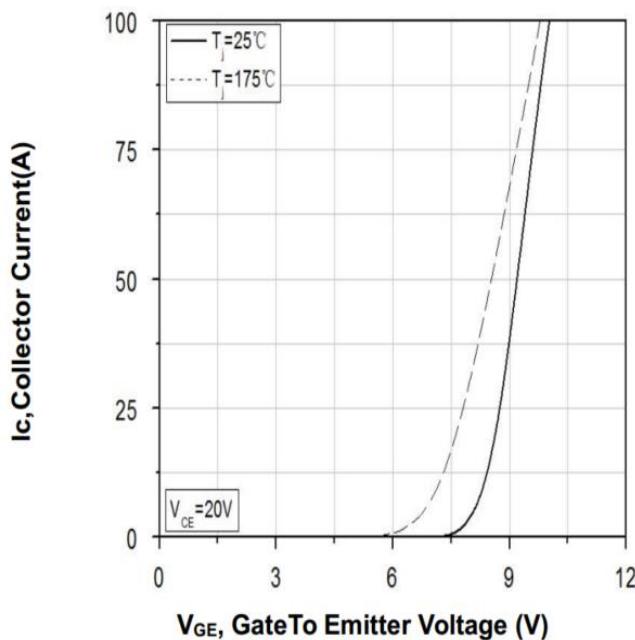


Fig. 1 Typical transfer characteristics  
( $V_{CE}=20\text{V}$ )

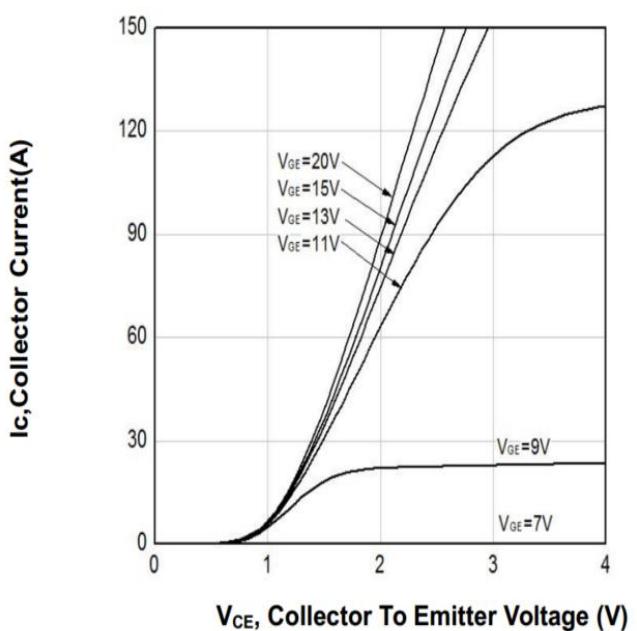


Fig. 2 Typical output characteristic ( $T_{vj}=25^\circ\text{C}$ )

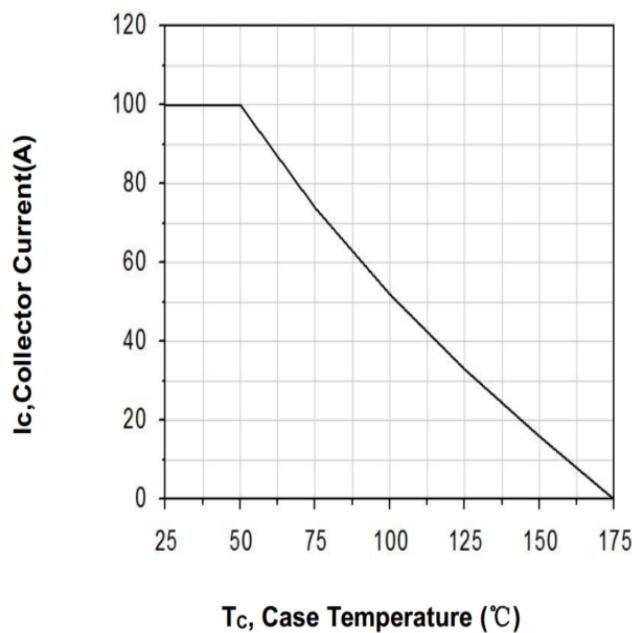


Fig. 3 Collector current as a function of case temperature ( $V_{GE}\geq 15\text{V}, T_{vj}\leq 175^\circ\text{C}$ )

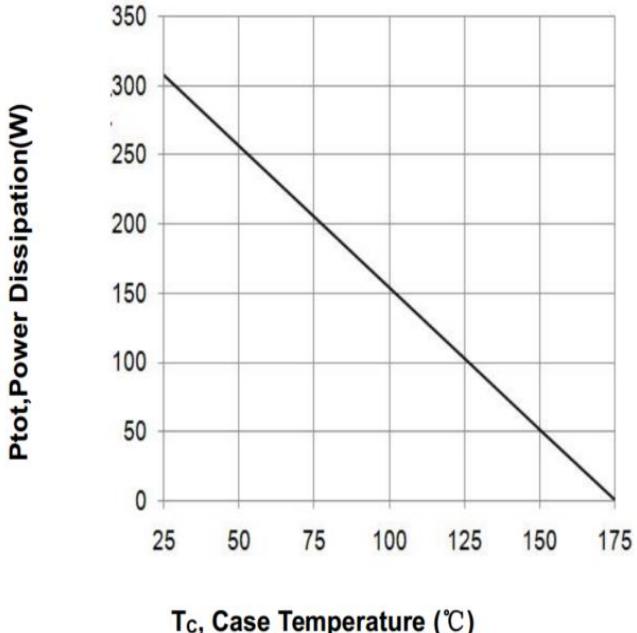
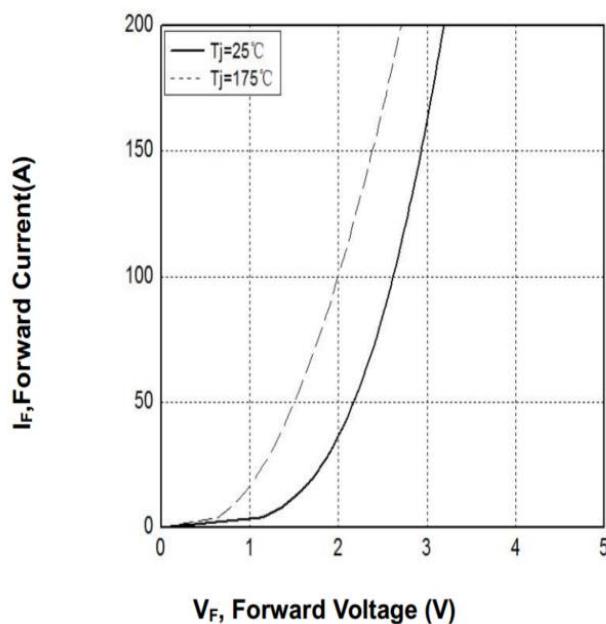
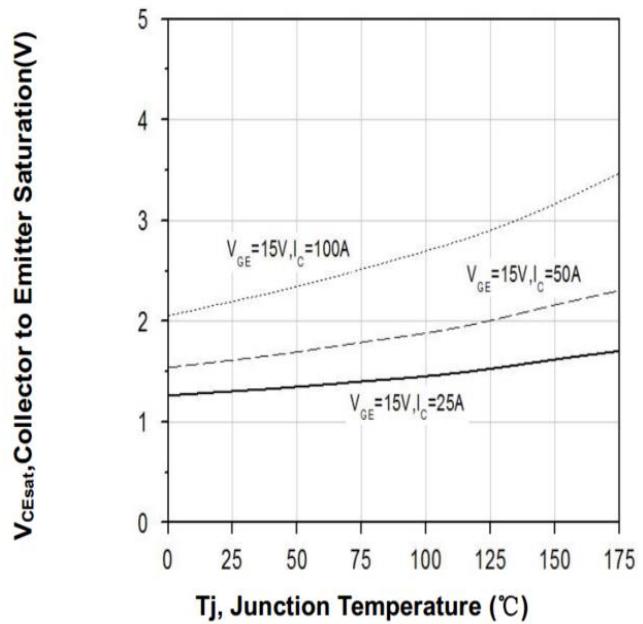


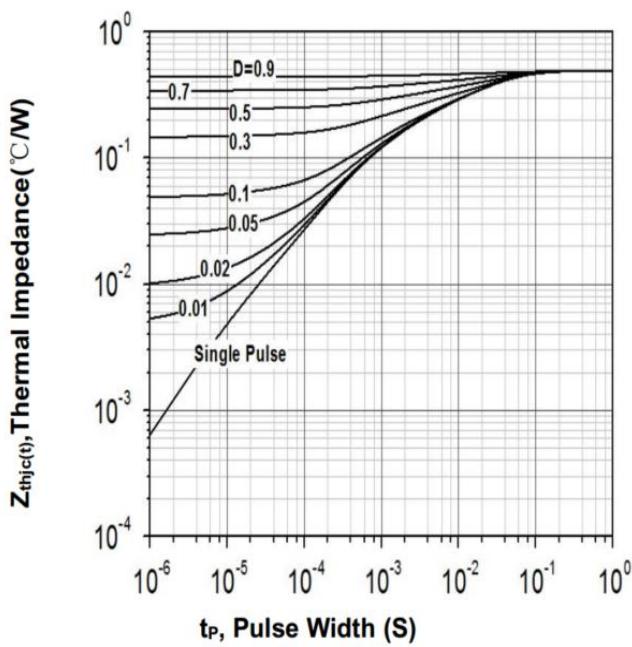
Fig. 4 Power dissipation as a function of case temperature ( $T_{vj}\leq 175^\circ\text{C}$ )



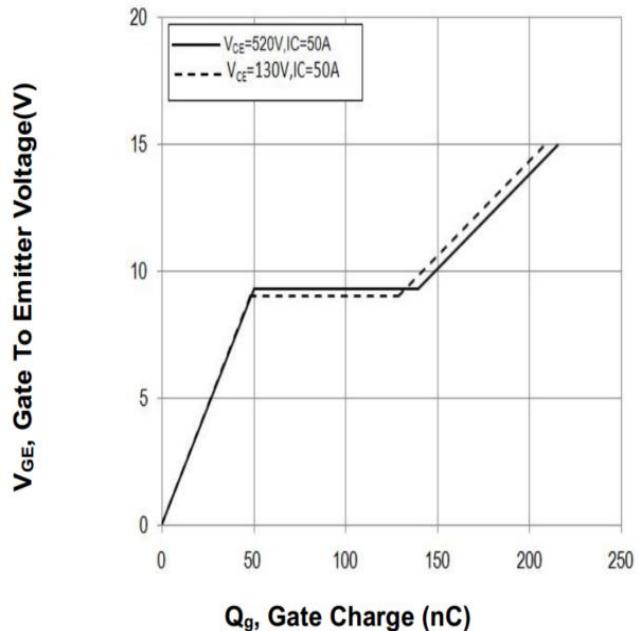
**Fig. 5** Gate-emitter threshold voltage as a function of junction temperature ( $I_C=0.60\text{mA}$ )



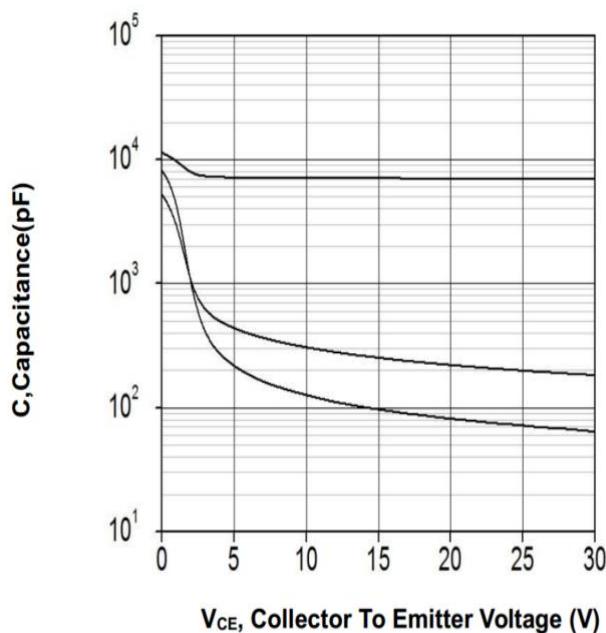
**Fig. 6** Typical collector-emitter saturation voltage as a function of junction temperature ( $V_{GE}=15\text{V}$ )



**Fig. 7** IGBT transient thermal impedance ( $D=t_p/T$ )



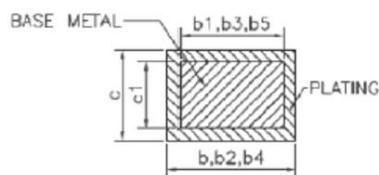
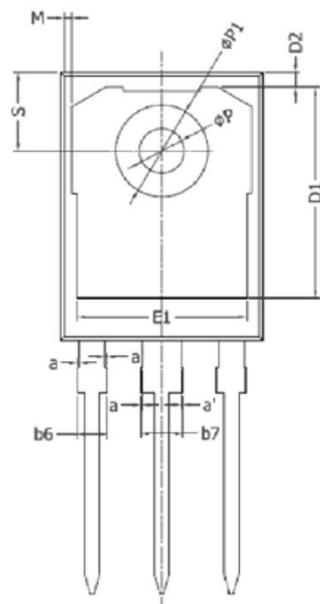
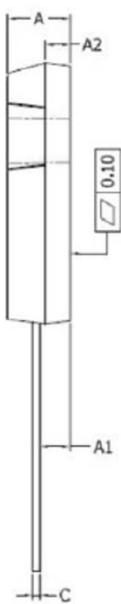
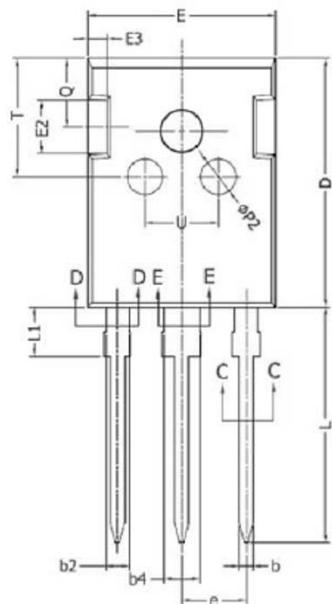
**Fig. 8** Typical gate charge



**Fig. 9** Typical capacitance as a function of  
collector-emitter voltage ( $V_{GE}=0V$ ,  $f=1MHz$ )

## Package Information

TO-247-3L



SECTION C-C,D-D &amp; E-E

SYMBOL	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0	—	0.15
a'	0	—	0.15
b	1.16	—	1.26
b1	1.15	1.2	1.22
b2	1.96	—	2.06
b3	1.95	2.00	2.02
b4	2.96	—	3.06
b5	2.96	3.00	3.02
b6	---	—	2.25
b7	---	—	3.25
c	0.59	—	0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.40	4.50	4.60
E3	1.50	1.60	1.70
e	5.436 BSC		
L	19.80	19.92	20.10
L1	---	—	4.30
M	0.35	—	0.95
P	3.40	3.50	3.60
P1	7.00	—	7.40
P2	2.40	2.50	2.60
Q	5.60	—	6.00
S	6.05	6.15	6.25
T	9.80	—	10.20
U	6.00	—	6.40